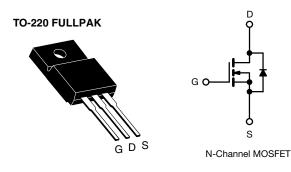
Vishay Siliconix



# **E Series Power MOSFET**



PRODUCT SUMMA	RY	
V <sub>DS</sub> (V) at T <sub>J</sub> max.	700	)
R <sub>DS(on)</sub> max. (Ω) at 25 °C	$V_{GS} = 10 V$	0.6
Q <sub>g</sub> max. (nC)	48	
Q <sub>gs</sub> (nC)	6	
Q <sub>gd</sub> (nC)	11	
Configuration	Sing	le

## FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (C<sub>iss</sub>)
- Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

## APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

# ORDERING INFORMATION Package TO-220 FULLPAK Lead (Pb)-free and Halogen-free SiHF6N65E-GE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V <sub>DS</sub>	650	v	
Gate-Source Voltage		V <sub>GS</sub>	± 30	v	
Continuous Drain Current (T, = 150 °C) <sup>e</sup>	$V_{GS} \text{ at } 10 \text{ V} \qquad \frac{T_{C} = 25 \text{ °C}}{T_{C} = 100 \text{ °C}}$		7		
Continuous Drain Current $(T_j = 150^{\circ} C)^{-1}$	$T_{\rm C} = 100 ^{\circ}{\rm C}$	I <sub>D</sub>	5	А	
Pulsed Drain Current <sup>a</sup>		I <sub>DM</sub>	18	-	
Linear Derating Factor			0.63	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>		E <sub>AS</sub>	56	mJ	
Maximum Power Dissipation		P <sub>D</sub>	31	W	
Operating Junction and Storage Temperature Range	)	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-Source Voltage Slope	T <sub>J</sub> = 125 °C	-l) / / -l+	37		
Reverse Diode dV/dt <sup>d</sup>		dV/dt	27	V/ns	
Soldering Recommendations (Peak temperature) <sup>c</sup>	For 10 s		300	°C	
Mounting Torque	M3 screw		0.6	Nm	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

- b.  $V_{DD}$  = 50 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 2 A.
- c. 1.6 mm from case.
- d.  $I_{SD} \leq I_D, \, dI/dt$  = 100 A/µs, starting  $T_J$  = 25 °C.

e. Limited by maximum junction temperature.

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1 For technical questions, contact: <u>hvm@vishay.com</u> www.vishay.com

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THERMAL RESISTANCE RAT	INGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-		65			00 AM	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-		4.0			°C/W	
		•						
<b>SPECIFICATIONS</b> ( $T_J = 25 \ ^{\circ}C$ , u	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> =	250 µA	650	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	I <sub>D</sub> = 1 mA	-	0.73	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> =	250 µA	2	-	4	V
	I <sub>GSS</sub>	$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA	
Gate-Source Leakage		,	$V_{GS} = \pm 30$	V	-	-	± 1	μA
Zaus Osta Valta as Dusis Ormant		V <sub>DS</sub> = 650 V, V <sub>GS</sub> = 0 V		-	-	1		
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = 520 V	$V_{DS} = 520 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$		-	-	10	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$		I <sub>D</sub> = 3 A	-	0.5	0.6	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub>	= 30 V, I <sub>D</sub>	= 3 A	-	2	-	S
Dynamic		•			•			
Input Capacitance	C <sub>iss</sub>		$V_{GS} = 0 V$	1	-	820	-	
Output Capacitance	C <sub>oss</sub>	$V_{\text{DS}} = 100 \text{ V},$ f = 1  MHz		-	40	-		
Reverse Transfer Capacitance	C <sub>rss</sub>			-	4	-		
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>	$V_{\text{DS}}$ = 0 V to 520 V, $V_{\text{GS}}$ = 0 V		-	36	-	pF	
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>			-	117	-	1	
Total Gate Charge	Qg				-	24	48	
Gate-Source Charge	Q <sub>gs</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 3 .	A, V <sub>DS</sub> = 520 V	-	6	-	nC
Gate-Drain Charge	Q <sub>gd</sub>				-	11	-	1
Turn-On Delay Time	t <sub>d(on)</sub>			-	14	28		
Rise Time	t <sub>r</sub>	V <sub>DD</sub>	= 520 V, I <sub>C</sub>	<sub>0</sub> = 3 A,	-	12	24	1
Turn-Off Delay Time	t <sub>d(off)</sub>	V <sub>GS</sub> =	$V_{GS}$ = 10 V, $R_g$ = 9.1 $\Omega$		-	30	60	ns
Fall Time	t <sub>f</sub>	]			-	20	40	1
Gate Input Resistance	R <sub>g</sub>	f = 1 MHz, open drain		-	1.4	-	Ω	
Drain-Source Body Diode Characteristi	cs							
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	MOSFET syml showing the	MOSFET symbol showing the		-	-	7	
Pulsed Diode Forward Current	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	18	A	
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °	C, I <sub>S</sub> = 3 A	, V <sub>GS</sub> = 0 V	-	-	1.3	V
Reverse Recovery Time					1	ł		
					-	237	-	ns
Reverse Recovery Charge	t <sub>rr</sub> Q <sub>rr</sub>	$T_{\rm J} = 2$	25 °C, I <sub>F</sub> = 100 Α/μs,	$I_{\rm S} = 3  \rm A,$	-	237 2.2	-	ns µC

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .



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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

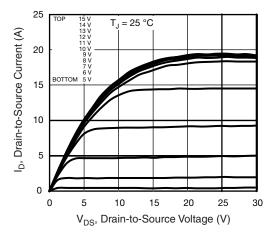


Fig. 1 - Typical Output Characteristics

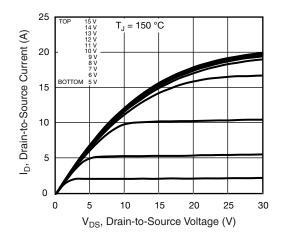


Fig. 2 - Typical Output Characteristics

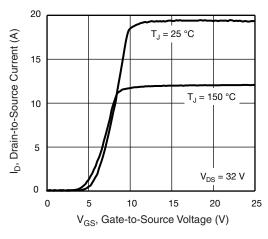


Fig. 3 - Typical Transfer Characteristics

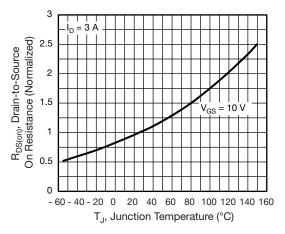


Fig. 4 - Normalized On-Resistance vs. Temperature

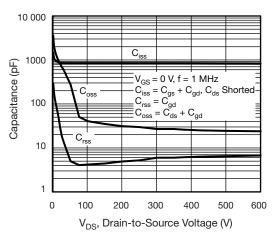
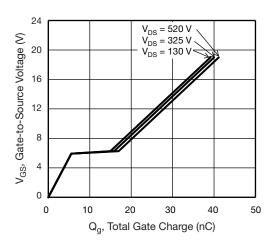


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





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3 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 91547

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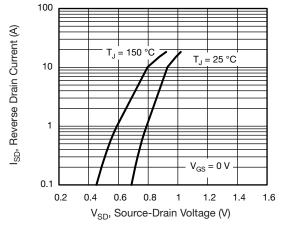


Fig. 7 - Typical Source-Drain Diode Forward Voltage

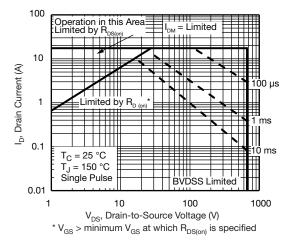


Fig. 8 - Maximum Safe Operating Area

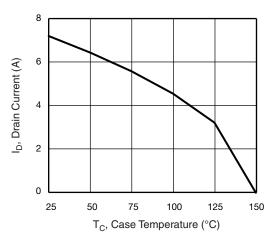


Fig. 9 - Maximum Drain Current vs. Case Temperature

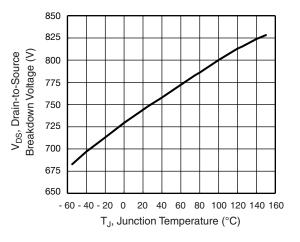
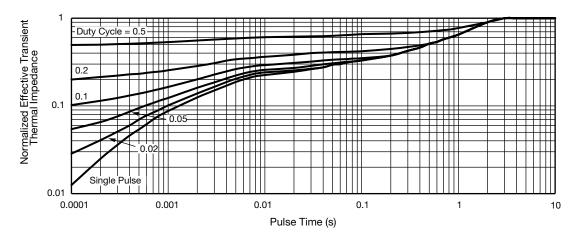


Fig. 10 - Temperature vs. Drain-to-Source Voltage





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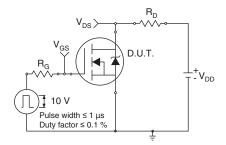


Fig. 12 - Switching Time Test Circuit

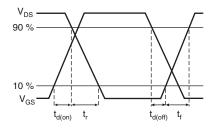


Fig. 13 - Switching Time Waveforms

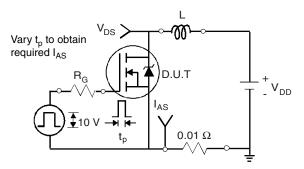


Fig. 14 - Unclamped Inductive Test Circuit

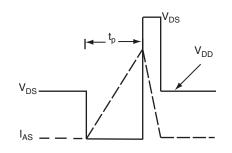


Fig. 15 - Unclamped Inductive Waveforms

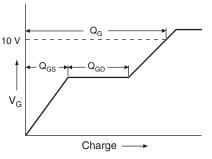


Fig. 16 - Basic Gate Charge Waveform

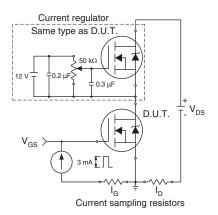
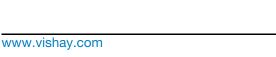


Fig. 17 - Gate Charge Test Circuit



SHAY

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### Peak Diode Recovery dV/dt Test Circuit

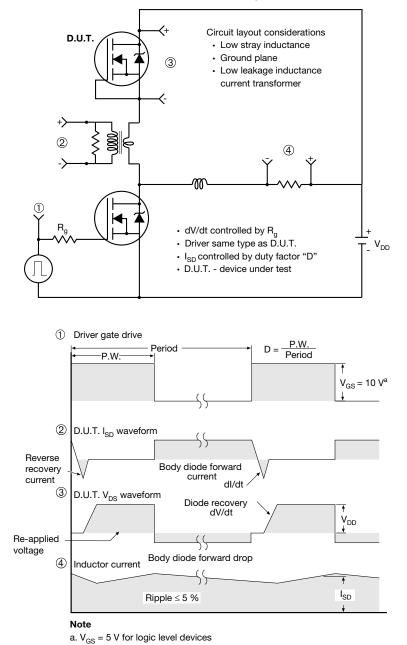


Fig. 18 - For N-Channel

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# **TO-220 FULLPAK (High Voltage)**

## **OPTION 1: FACILITY CODE = 9**



		MILLIMETERS	
DIM.	MIN.	NOM.	MAX.
A	4.60	4.70	4.80
b	0.70	0.80	0.91
b1	1.20	1.30	1.47
b2	1.10	1.20	1.30
С	0.45	0.50	0.63
D	15.80	15.87	15.97
е		2.54 BSC	
E	10.00	10.10	10.30
F	2.44	2.54	2.64
G	6.50	6.70	6.90
L	12.90	13.10	13.30
L1	3.13	3.23	3.33
Q	2.65	2.75	2.85
Q1	3.20	3.30	3.40
ØR	3.08	3.18	3.28

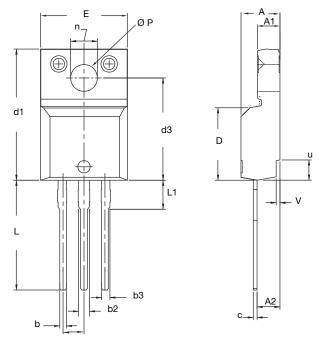
## Notes

- 1. To be used only for process drawing
- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet  $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
- Facility code will be the 1<sup>st</sup> character located at the 2<sup>nd</sup> row of the unit marking



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## **OPTION 2: FACILITY CODE = Y**



	MILLIN	MILLIMETERS		INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.		
А	4.570	4.830	0.180	0.190		
A1	2.570	2.830	0.101	0.111		
A2	2.510	2.850	0.099	0.112		
b	0.622	0.890	0.024	0.035		
b2	1.229	1.400	0.048	0.055		
b3	1.229	1.400	0.048	0.055		
С	0.440	0.629	0.017	0.025		
D	8.650	9.800	0.341	0.386		
d1	15.88	16.120	0.622	0.635		
d3	12.300	12.920	0.484	0.509		
E	10.360	10.630	0.408	0.419		
е	2.54	BSC	0.100	) BSC		
L	13.200	13.730	0.520	0.541		
L1	3.100	3.500	0.122	0.138		
n	6.050	6.150	0.238	0.242		
ØP	3.050	3.450	0.120	0.136		
u	2.400	2.500	0.094	0.098		
V	0.400	0.500	0.016	0.020		

DWG: 5972

## Notes

1. To be used only for process drawing

2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads

3. All critical dimensions should C meet  $C_{pk} > 1.33$ 

4. All dimensions include burrs and plating thickness

5. No chipping or package damage
6. Facility code will be the 1<sup>st</sup> character located at the 2<sup>nd</sup> row of the unit marking

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